Quad 1-of-2 video multiplexer/demultiplexer Rev. 03 — 5 August 2009

Product data sheet

#### **General description** 1.

The NX5DV330 is a quad 1-of-2 high-speed TTL-compatible video multiplexer/demultiplexer. The low ON resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise

It has a digital select input (S), four independent inputs/outputs (nY0, nY1), a common input/output (nZ) and an active LOW enable input ( $\overline{E}$ ). When pin  $\overline{E}$  is HIGH, the switch is turned off.

Schmitt-trigger action at the enable input ( $\overline{E}$ ) and select input (S) makes the circuit tolerant to slower input rise and fall times across the entire  $V_{CC}$  range from 4.0 V to 5.5 V.

The NX5DV330 is characterized for operation from -40 °C to +85 °C.

#### 2. **Features**

- 5 Ω switch connection between two ports
- TTL-compatible input levels
- Minimal propagation delay through the switch
- ESD protection:
  - HBM JESD22-A114E Class 2A exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101C exceeds 1000 V
- Latch-up testing is done to JEDEC standard JESD78 which exceeds 100 mA



## 3. Ordering information

Type number	Package						
	Temperature range	Name	Description	Version			
NX5DV330D	–40 °C to +85 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1			
NX5DV330DS	–40 °C to +85 °C	SSOP16 <sup>[1]</sup>	plastic shrink small outline package; 16 leads; body width 3.9 mm; lead pitch 0.635 mm	SOT519-1			
NX5DV330PW	–40 °C to +85 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1			
NX5DV330BQ	–40 °C to +85 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body $2.5 \times 3.5 \times 0.85$ mm	SOT763-7			

[1] Also known as QSOP16.

## 4. Functional diagram



Quad 1-of-2 video multiplexer/demultiplexer

## 5. Pinning information

## 5.1 Pinning



Pin configuration for SOT403-1 (TSSOP16)

Fig 5. Pin configuration for SOT763-1 (DHVQFN16)

### 5.2 Pin description

### Table 2.Pin description

Symbol	Pin	Description
S	1	select control input
1Y0, 1Y1, 2Y0, 2Y1, 3Y1, 3Y0, 4Y1, 4Y0	2, 3, 5, 6, 10, 11, 13, 14	independent input or output
1Z, 2Z, 3Z, 4Z	4, 7, 9, 12	independent input or output
GND	8	ground (0 V)
E	15	enable input (active LOW)
Vcc	16	positive supply voltage

Fig 4.

## 6. Functional description

### Table 3. Function selection

H = HIGH voltage level; L = LOW voltage level; X = Don't care.

E         S           L         L         Y0 to Z or Z to Y0           L         H         Y1 to Z or Z to Y1	
L H Y1 to Z or Z to Y1	
H X switch off	

## 7. Limiting values

#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7.0	V
VI	input voltage		<u>[1]</u> –0.5	+7.0	V
I <sub>SW</sub>	switch current	continuous current through each switch	-	128	mA
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-	-50	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation		[2][3][4]	500	mW

[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

[2] For SO16 package:  $P_{tot}$  derates linearly with 8 mW/K above 70 °C.

[3] For SSOP16 (QSOP16) and TSSOP16 packages: Ptot derates linearly with 5.5 mW/K above 60 °C.

[4] For DHVQFN16 packages: above 60 °C derate linearly with 4.5 mW/K.

## 8. Recommended operating conditions

#### Table 5.Operating conditions

All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		4.0	5.0	5.5	V
V <sub>IH</sub>	HIGH-level input voltage		2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage		-	-	0.8	V
V <sub>H</sub>	hysteresis voltage	pin S, Ē	-	45	-	mV
T <sub>amb</sub>	ambient temperature	operating in free-air	-40	+25	+85	°C

## 9. Static characteristics

#### Table 6. Static characteristics

 $T_{amb} = -40 \circ C$  to +85  $\circ C$ .

Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
input clamping voltage	$V_{CC} = 4.5 \text{ V}; I_I = -18 \text{ mA}$	-	-	-1.2	V
input leakage current	pin S, $\overline{E};V_{CC}$ = 5.5 V; V <sub>I</sub> = GND or 5.5 V	-	-	±1	μΑ
OFF-state leakage current	$V_{CC}$ = 5.5 V; $V_{I}$ = GND; $V_{O}$ = 0 V to 5.5 V	-	-	±1	μΑ
power-off leakage current	$V_{CC} = 0 \text{ V}; \text{ V}_{I} = V_{O} = 0 \text{ V} \text{ to } 5.5 \text{ V}$	-	-	±1	μΑ
supply current	$V_{CC}$ = 5.5 V; $I_{O}$ = 0 mA; $V_{I}$ = $V_{CC}$ or GND	-	-	3	μΑ
additional supply current	pin S, $\overline{E}$ ; V <sub>CC</sub> = 5.5 V; one input at 3.4 V, other inputs at V <sub>CC</sub> or GND	[2] _	-	2.5	mA
input capacitance	pin S, $\overline{E}$ ; V <sub>I</sub> = 5 V or 0 V	-	3.5	-	pF
off-state input/output	Z port; $V_{CC}$ = 5 V; $V_O$ = 5 V or 0 V; $\overline{E}$ = $V_{CC}$	-	6.0	-	pF
capacitance	Y port; $V_{CC}$ = 5 V; $V_O$ = 5 V or 0 V; $\overline{E}$ = $V_{CC}$	-	4.0	-	pF
on-state input/output capacitance	Z port; $V_{CC}$ = 5 V; $V_O$ = 5 V or 0 V; $\overline{E}$ = GND	-	14	-	pF
ON resistance	$V_{CC} = 4.5 V$	[3]			
	V <sub>I</sub> = 1.0 V; I <sub>I</sub> = 13 mA	-	3	7	Ω
	$V_{I} = 2.0 V; I_{I} = 26 mA$	-	7	10	Ω
	input clamping voltageinput leakage currentOFF-state leakage currentpower-off leakage currentsupply currentadditional supply currentinput capacitanceoff-state input/outputcapacitanceon-state input/outputcapacitance	$\label{eq:constant} \begin{array}{ll} \text{input clamping voltage} & V_{CC} = 4.5 \text{ V; } \text{I}_{\text{I}} = -18 \text{ mA} \\ \text{input leakage current} & \text{pin S, $\overline{\text{E}}; V_{CC} = 5.5 \text{ V; } V_{\text{I}} = \text{GND or } 5.5 \text{ V} \\ \text{OFF-state leakage current} & V_{CC} = 5.5 \text{ V; } V_{\text{I}} = \text{GND; } V_{O} = 0 \text{ V to } 5.5 \text{ V} \\ \text{power-off leakage current} & V_{CC} = 0 \text{ V; } V_{\text{I}} = V_{O} = 0 \text{ V to } 5.5 \text{ V} \\ \text{supply current} & V_{CC} = 5.5 \text{ V; } \text{I}_{\text{O}} = 0 \text{ mA; } V_{\text{I}} = V_{CC} \text{ or GND} \\ \text{additional supply current} & \text{pin S, $\overline{\text{E}}; V_{CC} = 5.5 \text{ V; one input at } 3.4 \text{ V,} \\ \text{other inputs at } V_{CC} \text{ or GND} \\ \text{input capacitance} & \text{pin S, $\overline{\text{E}}; V_{\text{I}} = 5 \text{ V or } 0 \text{ V} \\ \text{off-state input/output} & \text{Z port; } V_{CC} = 5 \text{ V; } V_{O} = 5 \text{ V or } 0 \text{ V; $\overline{\text{E}} = V_{CC} \\ \text{Y port; } V_{CC} = 5 \text{ V; } V_{O} = 5 \text{ V or } 0 \text{ V; $\overline{\text{E}} = V_{CC} \\ \end{array} \\ \text{on-state input/output} & \text{Z port; } V_{CC} = 5 \text{ V; } V_{O} = 5 \text{ V or } 0 \text{ V; $\overline{\text{E}} = 0 \text{ N} \\ \text{capacitance} & \text{CON resistance} \\ \end{array} \\ \begin{array}{l} \text{ON resistance} & V_{CC} = 4.5 \text{ V} \\ \text{V}_{\text{I}} = 1.0 \text{ V; } \text{I}_{\text{I}} = 13 \text{ mA} \\ \end{array} $	input clamping voltage $V_{CC} = 4.5 \text{ V}; \text{ I}_{\text{I}} = -18 \text{ mA}$ -input leakage currentpin S, $\overline{E}; V_{CC} = 5.5 \text{ V}; V_{\text{I}} = \text{GND or } 5.5 \text{ V}$ -OFF-state leakage current $V_{CC} = 5.5 \text{ V}; V_{\text{I}} = \text{GND}; V_{O} = 0 \text{ V to } 5.5 \text{ V}$ -power-off leakage current $V_{CC} = 0 \text{ V}; V_{\text{I}} = V_{O} = 0 \text{ V to } 5.5 \text{ V}$ -supply current $V_{CC} = 5.5 \text{ V}; I_{O} = 0 \text{ mA}; V_{\text{I}} = V_{CC} \text{ or GND}$ -additional supply currentpin S, $\overline{E}; V_{CC} = 5.5 \text{ V};$ one input at $3.4 \text{ V},$ other inputs at $V_{CC}$ or GND-input capacitancepin S, $\overline{E}; V_{\text{I}} = 5 \text{ V}$ or $0 \text{ V}$ -off-state input/output capacitanceZ port; $V_{CC} = 5 \text{ V}; V_{O} = 5 \text{ V}$ or $0 \text{ V}; \overline{E} = V_{CC}$ -on-state input/output capacitanceZ port; $V_{CC} = 5 \text{ V}; V_{O} = 5 \text{ V}$ or $0 \text{ V}; \overline{E} = \text{GND}$ -ON resistance $V_{CC} = 4.5 \text{ V}$ $V_{\text{I}} = 1.0 \text{ V}; \text{ I} = 13 \text{ mA}$ -	$\begin{array}{llllllllllllllllllllllllllllllllllll$	$\begin{array}{llllllllllllllllllllllllllllllllllll$

[1] All typical values are measured at V<sub>CC</sub> = 5 V;  $T_{amb}$  = 25 °C.

[2] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

[3] Measured by the voltage drop between the Z and the Y terminals at the indicated current through the switch. ON-state resistance is determined by the lowest voltage of the two (Z or Y) terminals.

## **10.** Dynamic characteristics

#### Table 7. Dynamic characteristics

 $T_{amb} = -40 \degree C$  to +85 °C; for test circuit see Figure 7.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t <sub>on</sub>	turn-on time	S to nZ; see Figure 6				
		$V_{CC}$ = 4.5 V to 5.5 V	-	4.0	6.0	ns
t <sub>off</sub>	turn-off time	S to nZ; see Figure 6				
		$V_{CC}$ = 4.5 V to 5.5 V	-	2.3	6.0	ns

### Quad 1-of-2 video multiplexer/demultiplexer

## 11. Waveforms



### Table 8. Measurement points

Supply voltage	Input		Output
V <sub>cc</sub>	VI	V <sub>M</sub>	V <sub>Y</sub>
4.5 V to 5.5 V	GND to 3.0 V	1.5 V	0.9V <sub>OH</sub>



#### Table 9.Test data

Input					Load	
VI	f <sub>i</sub>	t <sub>r</sub> , t <sub>f</sub>	V <sub>Y0</sub>	V <sub>Y1</sub>	RL	CL
GND to 3.0 V	$\leq$ 10 MHz	≤ 2.5 ns	GND to 3.0 V	3.0 V to GND	75 Ω	20 pF

## **12. Additional dynamic characteristics**

#### Table 10. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V);  $V_I = GND$  or  $V_{CC}$  (unless otherwise specified);  $T_{amb} = 25 \degree C$ ;  $V_{CC} = 4.5 \lor to 5.5 \lor$ .

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
G <sub>dif</sub>	differential gain	$f_i$ = 3.58 MHz; R <sub>L</sub> = 150 Ω		-	0.64	-	%
φ <sub>dif</sub>	differential phase	$f_i$ = 3.58 MHz; R <sub>L</sub> = 150 Ω		-	0.1	-	deg
$f_{(-3dB)}$	-3 dB frequency response	$R_L = 150 \Omega$ ; see Figure 8		300	-	-	MHz
$\alpha_{\text{iso}}$	isolation (OFF-state)	$f_i = 10 \text{ MHz}; \text{ R}_L = 150 \Omega; \text{ see } \frac{\text{Figure 9}}{1000}$		-	-60	-	dB
Xtalk	crosstalk	between switches; see Figure 10; $f_i = 10 \text{ MHz}$ ; $R_L = 150 \Omega$ ; $R_i = 10 \Omega$	<u>[1]</u>	-	-63	-	dB

[1] All unused analog input pins (nZ) and outputs pins (nYn) are connected through 10 Ω and 50 Ω pull-down resistors, respectively.

## 13. Test circuits





### **NXP Semiconductors**

## NX5DV330

### Quad 1-of-2 video multiplexer/demultiplexer



### **NXP Semiconductors**

## NX5DV330

Quad 1-of-2 video multiplexer/demultiplexer

## 14. Package outline



### Fig 11. Package outline SOT109-1 (SO16)

Quad 1-of-2 video multiplexer/demultiplexer



### SSOP16: plastic shrink small outline package; 16 leads; body width 3.9 mm; lead pitch 0.635 mm SOT519-1

Fig 12. Package outline SOT519-1 (SSOP16)

Quad 1-of-2 video multiplexer/demultiplexer



Fig 13. Package outline SOT403-1 (TSSOP16)

Quad 1-of-2 video multiplexer/demultiplexer



DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

### Fig 14. Package outline SOT763-1 (DHVQFN16)

## **15. Abbreviations**

Table 11.	Abbreviations
Acronym	Description
CDM	Charged Device Model
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

## **16. Revision history**

### Table 12.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NX5DV330_3	20090805	Product data sheet	-	NX5DV330_2
Modifications:	<ul> <li>Added type</li> </ul>	number NX5DV330BQ (DH)	/QFN16 package)	
NX5DV330_2	20080825	Product data sheet	-	NX5DV330_1
NX5DV330_1	20080815	Product data sheet	-	-

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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